

High Current Density Surface Mount Ultrafast Rectifiers

ESH2PB, ESH2PC, ESH2PD
Vishaymas General Semiconductor



DO-220AA (SMP)

FEATURES

- Very low profile - typical height of 1.0 mm
- Ideal for automated placement
- Glass passivated pellet chip junction
- Ultrafast recovery times for high frequency
- Low forward voltage drop, low power losses
- Low thermal resistance
- Meets MSL level 1 per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishaymas.com

TYPICAL APPLICATIONS

For use in secondary rectification and freewheeling for ultrafast switching speeds of AC/DC and DC/DC converters in high temperature for both consumer and automotive applications.

MECHANICAL DATA

Case: DO-220AA (SMP)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade
Base P/NHM3 - halogen-free, RoHS-compliant, and automotive grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

PRIMARY CHARACTERISTICS	
I _{F(AV)}	2.0 A
V _{RRM}	100 V, 150 V, 200 V
t _{rr}	25 ns
V _F at I _F = 2 A	0.75 V
T _J max.	175 °C
Package	DO-220AA (SMP)
Diode variations	Single die

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	ESH2PB	ESH2PC	ESH2PD	UNIT
Device marking code		P2B	P2C	P2D	
Maximum repetitive peak reverse voltage	V _{RRM}	100	150	200	V
Maximum average forward rectified current (fig. 1)	I _{F(AV)}		2.0		A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}		50		A
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175			°C

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum instantaneous forward voltage	$I_F = 2 \text{ A}$	$T_J = 25^\circ\text{C}$	V_F ⁽¹⁾	0.90	0.98	V
		$T_J = 125^\circ\text{C}$		0.75	0.82	
Maximum reverse current at rated V_R		$T_J = 25^\circ\text{C}$	I_R ⁽²⁾	0.2	1.0	μA
		$T_J = 125^\circ\text{C}$		12.6	25	
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, I_{rr} = 0.25 \text{ A}$		t_{rr}	-	25	ns
Typical reverse recovery time	$I_F = 1.0 \text{ A}, V_R = 30 \text{ V}, dI/dt = 50 \text{ A}/\mu\text{s}, I_{rr} = 10 \% I_{RM}$	$T_J = 25^\circ\text{C}$	t_{rr}	25	-	ns
		$T_J = 100^\circ\text{C}$		35	-	
Typical stored charge	$I_F = 1.0 \text{ A}, V_R = 30 \text{ V}, dI/dt = 50 \text{ A}/\mu\text{s}, I_{rr} = 10 \% I_{RM}$	$T_J = 25^\circ\text{C}$	Q_{rr}	10	-	nC
		$T_J = 100^\circ\text{C}$		15	-	
Typical junction capacitance	4.0 V, 1 MHz		C_J	25	-	pF

Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	ESH2PB	ESH2PC	ESH2PD	UNIT	
Typical thermal resistance	$R_{\theta JA}$ ⁽¹⁾	80			$^\circ\text{C/W}$	
	$R_{\theta JL}$ ⁽¹⁾	15				
	$R_{\theta JC}$ ⁽¹⁾	22				

Note

(1) Thermal resistance from junction to ambient and junction to lead mounted on PCB with 6.0 mm x 6.0 mm copper pad areas. $R_{\theta JL}$ is measured at the terminal of cathode band. $R_{\theta JC}$ is measured at the top center of the body

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
ESH2PB-M3/84A	0.024	84A	3000	7" diameter plastic tape and reel	
ESH2PB-M3/85A	0.024	85A	10 000	13" diameter plastic tape and reel	
ESH2PBHM3/84A ⁽¹⁾	0.024	84A	3000	7" diameter plastic tape and reel	
ESH2PBHM3/85A ⁽¹⁾	0.024	85A	10 000	13" diameter plastic tape and reel	

Note

(1) Automotive grade

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)

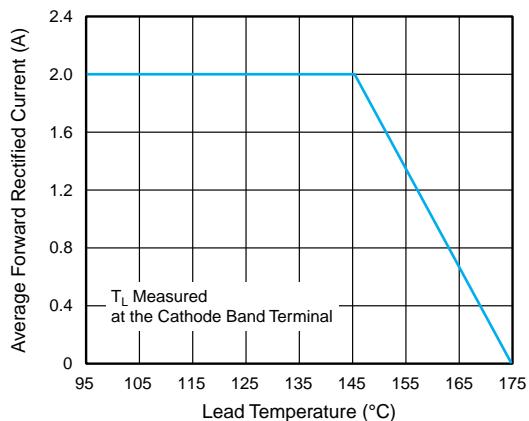


Fig. 1 - Maximum Forward Current Derating Curve

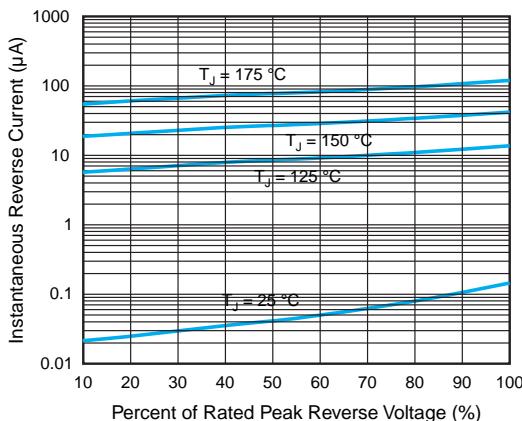


Fig. 4 - Typical Reverse Leakage Characteristics

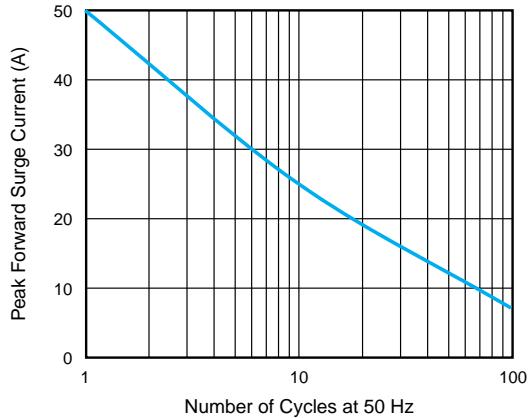


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

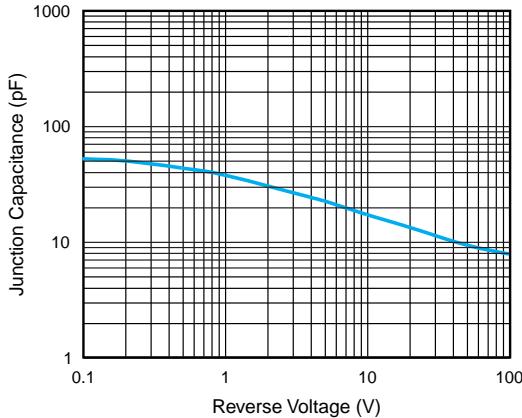


Fig. 5 - Typical Junction Capacitance

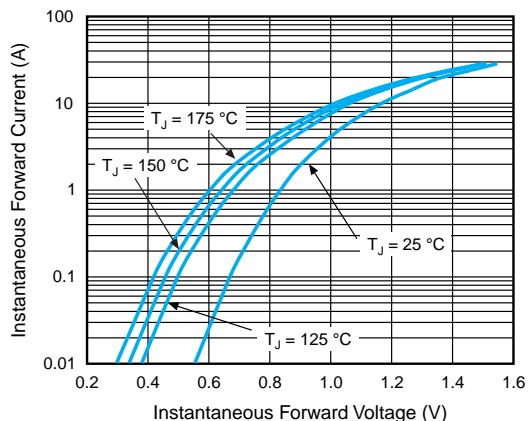


Fig. 3 - Typical Instantaneous Forward Characteristics

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-220AA (SMP)

